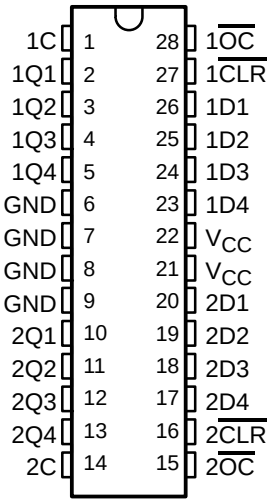
- **Inputs Are TTL-Voltage Compatible**
- **3-State Buffer-Type Outputs Drive Bus Lines Directly**
- **Bus-Structured Pinout**
- **Flow-Through Architecture to Optimize PCB Layout**
- **Center-Pin $V_{CC}$ and GND Configurations to Minimize High-Speed Switching Noise**
- **EPIC™ (Enhanced-Performance Implanted CMOS) 1-μm Process**
- **500-mA Typical Latch-Up Immunity at 125°C**
- **Package Options Include Plastic Small-Outline Packages and Standard Plastic 300-mil DIPs**

**DW OR NT PACKAGE**
**(TOP VIEW)**




## description

These dual 4-bit registers feature 3-state outputs designed specifically for bus driving. This makes these devices particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The dual 4-bit latch is transparent D-type. When the latch enable input (1C or 2C) is high, the (Q) outputs will follow the data (D) inputs in true form, according to the function table. When the latch enable input is taken low, the outputs will be latched. When $\overline{CLR}$ goes low, the Q outputs go low independently of enable C. The outputs are in a high-impedance state when $\overline{OC}$ (output control) is at a high logic level.

The 74ACT11873 is characterized for operation from – 40°C to 85°C.

**FUNCTION TABLE**

| INPUTS | | | | OUTPUT |
|---|---|---|---|---|
| $\overline{OC}$ | $\overline{CLR}$ | C | D | Q |
| L | L | X | X | L |
| L | H | H | H | H |
| L | H | H | L | L |
| L | H | L | X | $Q_O$ |
| H | X | X | X | Z |

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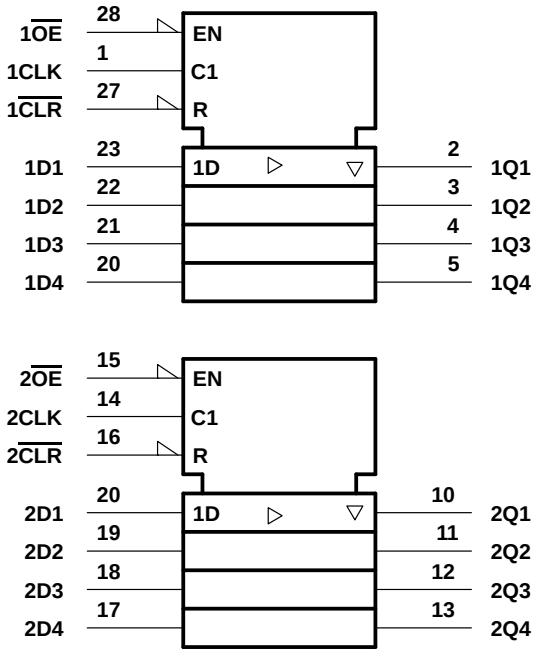
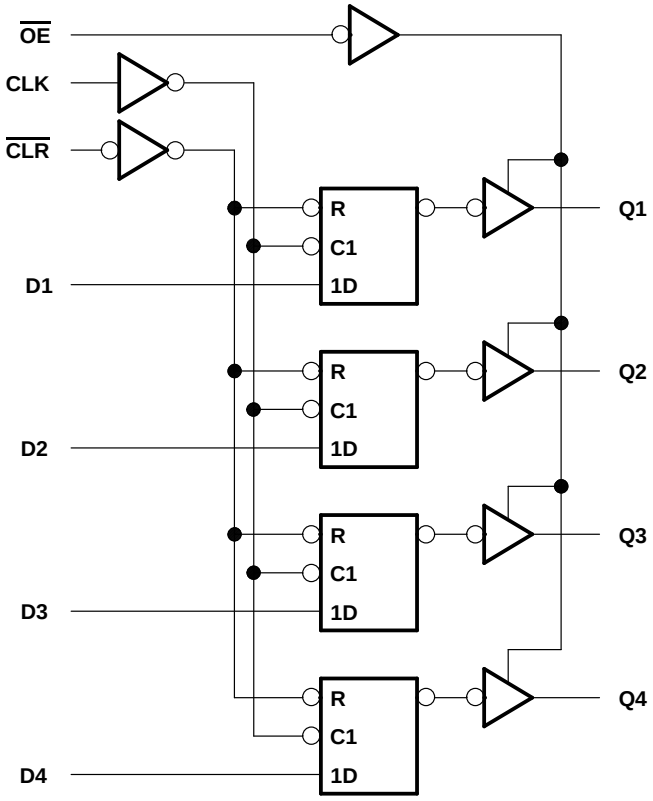
### logic symbol†




† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)

**each quad latch**




### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, $V_{CC}$ . . . . . –0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1) . . . . . –0.5 V to $V_{CC}$ + 0.5 V
Output voltage range, $V_O$ (see Note 1) . . . . . –0.5 V to $V_{CC}$ + 0.5 V
Input clamp current, $I_{IK}$ ($V_I$ < 0 or $V_I$ > $V_{CC}$) . . . . . ± 20 mA
Output clamp current, $I_{OK}$ ($V_O$ < 0 or $V_O$ > $V_{CC}$) . . . . . ± 50 mA
Continuous output current, $I_O$ ($V_O$ = 0 to $V_{CC}$) . . . . . ± 50 mA
Continuous current through $V_{CC}$ or GND . . . . . ± 200 mA
Storage temperature range . . . . . –65°C to 150°C

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## recommended operating conditions

| | | MIN | MAX | UNIT |
|---|---|---|---|---|
| $V_{CC}$ | Supply voltage | 4.5 | 5.5 | V |
| $V_{IH}$ | High-level input voltage | 2 | | V |
| $V_{IL}$ | Low-level input voltage | | 0.8 | V |
| $V_I$ | Input voltage | 0 | $V_{CC}$ | V |
| $V_O$ | Output voltage | 0 | $V_{CC}$ | V |
| $I_{OH}$ | High-level output current | | –24 | mA |
| $I_{OL}$ | Low-level output current | | 24 | mA |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | 0 | 10 | ns/V |
| $T_A$ | Operating free-air temperature | – 40 | 85 | °C |

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | $V_{CC}$ | $T_A$ = 25°C | | | MIN | MAX | UNIT |
|---|---|---|---|---|---|---|---|---|
| | | | MIN | TYP | MAX | | | |
| $V_{OH}$ | $I_{OH}$ = – 50 μA | 4.5 V | 4.4 | | | 4.4 | | V |
| | | 5.5 V | 5.4 | | | 5.4 | | |
| | $I_{OH}$ = – 24 mA | 4.5 V | 3.94 | | | 3.8 | | |
| | | 5.5 V | 4.94 | | | 4.8 | | |
| | $I_{OH}$ = – 75 mA† | 5.5 V | | | | 3.85 | | |
| $V_{OL}$ | $I_{OL}$ = 50 μA | 4.5 V | | | 0.1 | | 0.1 | V |
| | | 5.5 V | | | 0.1 | | 0.1 | |
| | $I_{OL}$ = 24 mA | 4.5 V | | | 0.36 | | 0.44 | |
| | | 5.5 V | | | 0.36 | | 0.44 | |
| | $I_{OL}$ = 75 mA† | 5.5 V | | | | | 1.65 | |
| $I_{OZ}$ | $V_O = V_{CC}$ or GND | 5.5 V | | | ± 0.5 | | ± 5 | μA |
| $I_I$ | $V_I = V_{CC}$ or GND | 5.5 V | | | ± 0.1 | | ± 1 | μA |
| $I_{CC}$ | $V_I = V_{CC}$ or GND, $I_O$ = 0 | 5.5 V | | | 8 | | 80 | μA |
| $\Delta I_{CC}$‡ | One input at 3.4 V, Other inputs at GND or $V_{CC}$ | 5.5 V | | | 0.9 | | 1 | mA |
| $C_i$ | $V_I = V_{CC}$ or GND | 5 V | | 4.5 | | | | pF |
| $C_o$ | $V_O = V_{CC}$ or GND | 5 V | | 13.5 | | | | pF |

† Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.
‡ This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V to $V_{CC}$.

## timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

| | | | $T_A$ = 25°C | | MIN | MAX | UNIT |
|---|---|---|---|---|---|---|---|
| | | | MIN | MAX | | | |
| $t_w$ | Pulse duration | $\overline{CLR}$ low | 5 | | 5 | | ns |
| | | C high | 5 | | 5 | | |
| $t_{su}$ | Setup time before C ↓ | Data high | 6 | | 6 | | ns |
| | | Data low | 3 | | 3 | | |
| $t_h$ | Hold time after C ↓ | Data high | 0 | | 0 | | ns |
| | | Data low | 0 | | 0 | | |

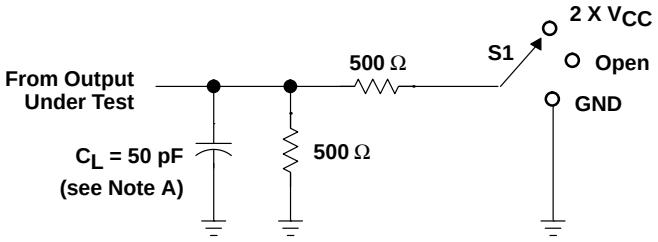
**switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)**

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $T_A$ = 25°C | | | MIN | MAX | UNIT |
|---|---|---|---|---|---|---|---|---|
| | | | MIN | TYP | MAX | | | |
| $t_{PLH}$ | D | Q | 4.4 | 7.2 | 8.8 | 4.4 | 10 | ns |
| $t_{PHL}$ | | | 3 | 6.6 | 9.1 | 3 | 10.2 | |
| $t_{PLH}$ | C | Q | 4.7 | 8.1 | 10 | 4.7 | 11.3 | ns |
| $t_{PHL}$ | | | 5.2 | 8.9 | 10.9 | 5.2 | 12.3 | |
| $t_{PHL}$ | $\overline{CLR}$ | Q | 2.9 | 6.5 | 9 | 2.9 | 10 | ns |
| $t_{PZH}$ | $\overline{OC}$ | Q | 1.9 | 4.9 | 7.1 | 1.9 | 8 | ns |
| $t_{PZL}$ | | | 2.7 | 6.4 | 9.1 | 2.7 | 10.3 | |
| $t_{PHZ}$ | $\overline{OC}$ | Q | 5.7 | 8 | 9.5 | 5.7 | 10.2 | ns |
| $t_{PLZ}$ | | | 5.2 | 7.8 | 9.1 | 5.2 | 9.8 | |

**operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C**

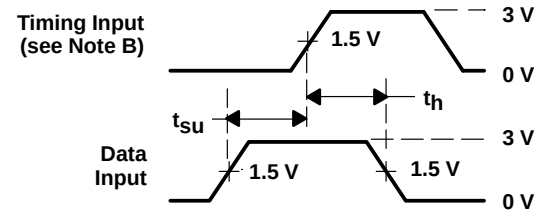
| PARAMETER | | | TEST CONDITIONS | TYP | UNIT |
|---|---|---|---|---|---|
| $C_{pd}$ | Power dissipation capacitance per latch | Outputs enabled | $C_L$ = 50 pF, f = 1 MHz | 40 | pF |
| | | Outputs disabled | | 7 | |

## PARAMETER MEASUREMENT INFORMATION

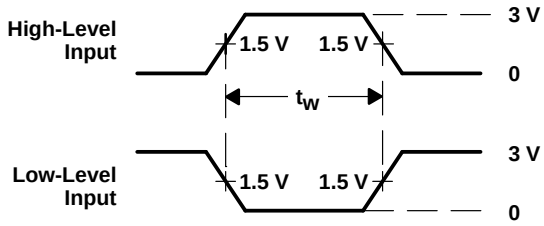



| TEST | S1 |
|---|---|
| $t_{PLH}/t_{PHL}$ | Open |
| $t_{PLZ}/t_{PZL}$ | 2 x $V_{CC}$ |
| $t_{PHZ}/t_{PZH}$ | GND |

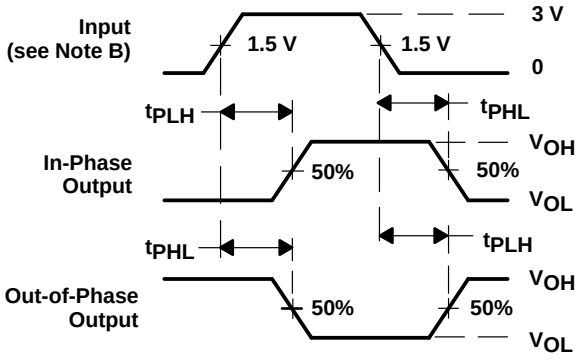
LOAD CIRCUIT



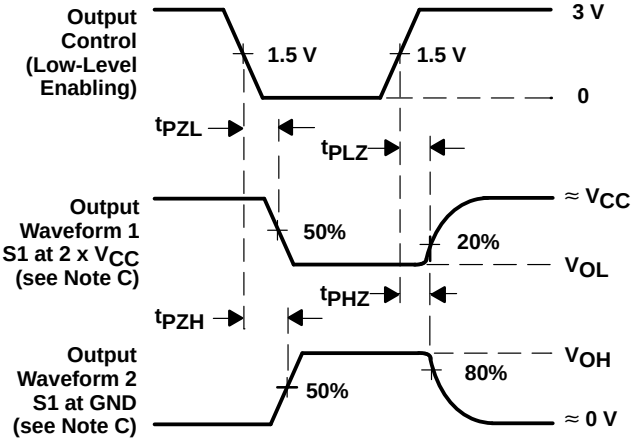

VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES




VOLTAGE WAVEFORMS
PULSE DURATION




VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES




VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

NOTES: A. $C_L$ includes probe and jig capacitance.
B. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, $Z_O$ = 50 Ω, $t_r$ ≤ 2.5 ns, $t_f$ ≤ 2.5 ns.
C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
D. The outputs are measured one at a time with one transition per measurement.

**Figure 1. Load Circuit and Voltage Waveforms**

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